LTCC SURFACE MOUNT

High Pass Filter

HFHKI-6600+

50Ω 7.2 to 17 GHz

THE BIG DEAL

- Integrated CPWG Interposer for Easy SMT Integration
- Insertion Loss, Typ. 1.6 dB
- Strong Stopband Rejection
- Power Handling: 6 W
- Protected by US Patents 11,638,370 and 11,744,057

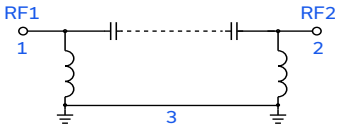


Generic photo used for illustration purposes only

APPLICATIONS

- Test and Measurement Equipment
- Microwave Transmitters / Receivers
- Harmonic Rejection
- Satellite Communications

FUNCTIONAL DIAGRAM



PRODUCT OVERVIEW

Mini-Circuits' HFHKI-6600+ is a passive RF high pass filter featuring a CPWG interposer that simplifies board-level implementation and supports compact RF designs. The device provides low insertion loss, good return loss and excellent suppression of adjacent bands and unwanted signals across a broad frequency range. Its shielded LTCC construction helps prevent de-tuning and EMI while maintaining stable performance over temperature. The compact 2.95 × 2.46 mm package is optimized for high-density RF and microwave applications.

ELECTRICAL SPECIFICATIONS[1,2,3] AT +25 °C Z_0 = 50 Ω

Parameter		F#	Frequency (GHz)	Min.	Typ.	Max.	Units
Passband	Insertion Loss	F4–F5	7.2–8.7	—	2.5	—	dB
		F5–F6	8.7–15.5	—	1.6	2.3	
		F6–F7	15.5–17	—	3.1	—	
	Freq. Cut-Off[4]	Fc	6.6	—	3	—	dB
	Return Loss	F4-F5	7.2–8.7	-	8.5	—	dB
		F5-F6	8.7–15.5	8.5	11	—	dB
		F6-F7	15.5–17	—	7	—	dB
Stopband	Rejection	DC–F1	DC–1.75	50	60	—	dB
		F1–F2	1.75–3.5	37	47	—	
		F2–F3	3.5–4.9	20	27	—	

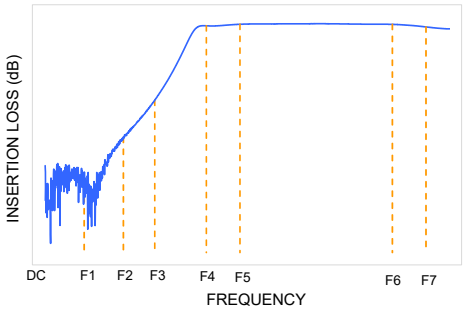
1. Tested in Evaluation Board P/N TB-HFHKI-6600C+ with the connector and feedline effects de-embedded using the 2X Thru IEEE P370 method.
2. This filter is bi-directional RF1 and RF2 ports may be interchanged, see S-Parameters for actual performance.
3. This component should not be used as a DC-block. In applications where DC voltage and/or current is present at either the input or output ports, external DC blocking capacitors are required.
4. Typical variation ± 5 %

ABSOLUTE MAXIMUM RATINGS[5]

Parameter	Ratings
Operating Temperature	-55 °C to +125 °C
Storage Temperature	-55 °C to +125 °C
Input Power[6]	6 W @ +25 °C

5. Permanent damage may occur if any of these limits are exceeded.
6. Power rating applies only to signals within the passband. Power rating above +25 °C operating temperature decreases linearly to 1 W at +125 °C.

TYPICAL FREQUENCY RESPONSE



REV. OR
ECO-030940
HFHKI-6600+
MCL NY
260828

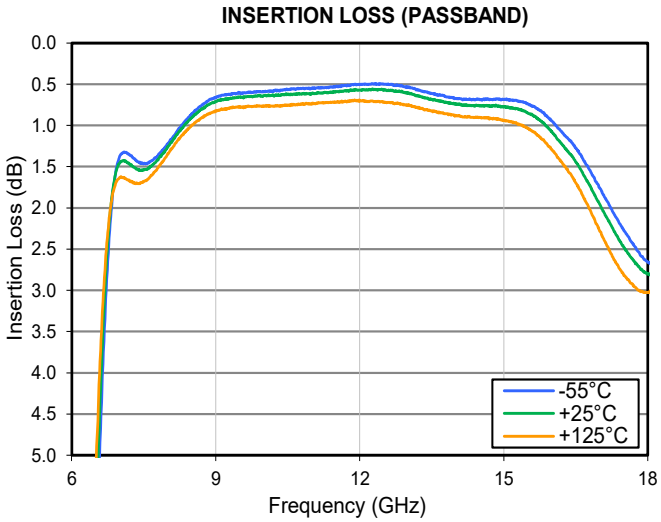
High Pass Filter

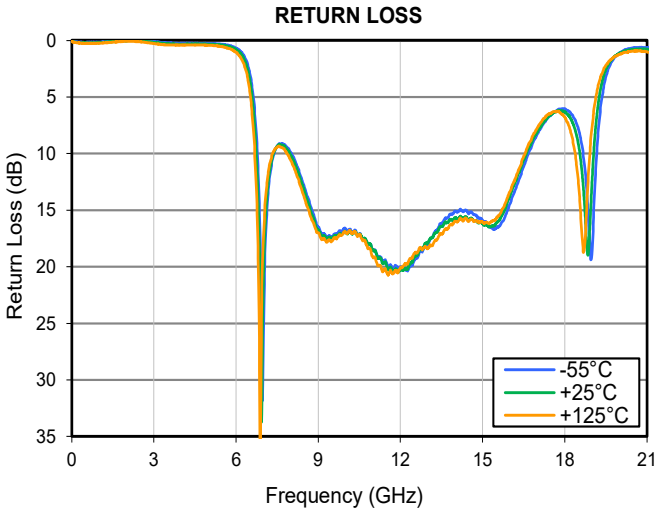
HFHKI-6600+

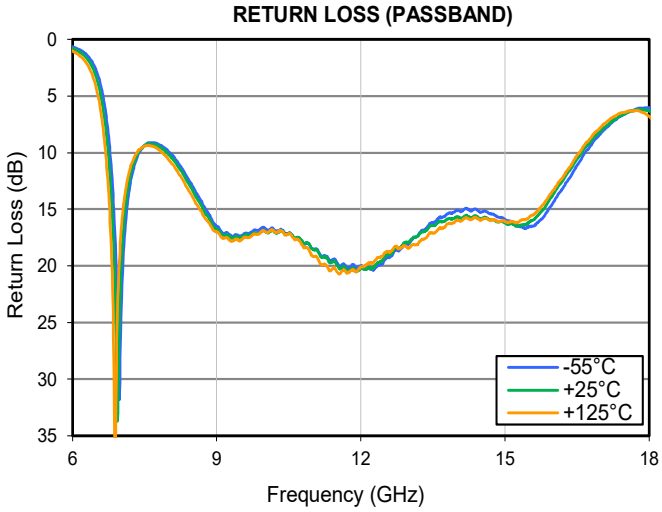
50Ω 7.2 to 17 GHz

TYPICAL PERFORMANCE GRAPHS









LTCC SURFACE MOUNT

High Pass Filter

HFHKI-6600+

50Ω 7.2 to 17 GHz

FUNCTIONAL DIAGRAM

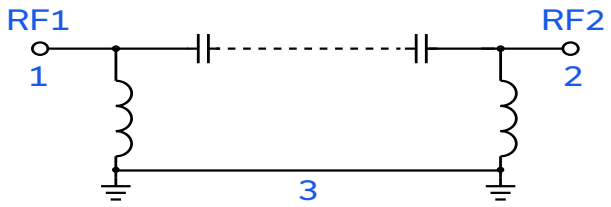
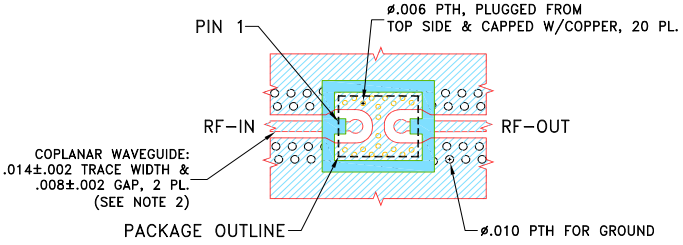


Figure 1. HFHKI-6600+ Functional Diagram

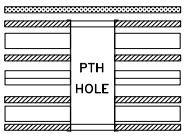
PAD DESCRIPTION

Function	Pad Number	Description
RF1[2]	1	Connects to RF Input Port
RF2[2]	2	Connects to RF Output Port
GROUND	3	Connects to Ground on PCB, (See drawing PL-837)

SUGGESTED PCB LAYOUT (PL-837)



STACK–UP DIAGRAM



–SOLDER MASK (TOP–SLD)
–COPPER LAYER 1(L1), .5 OZ.
–CORE 1, .0079 MEGTRON–7 R5785(N/GN)
–COPPER LAYER 2 (L2), .5 OZ.
–PREPREG, .0035 (89 um) MEGTRON–7 R5680(N/GN), CLOTH STYLE:1078
–PREPREG, .0035 (89 um) MEGTRON–7 R5680(N/GN), CLOTH STYLE:1078
–COPPER LAYER 3 (L3), .5 OZ.
–CORE 2, .0079 MEGTRON–7 R5785(N/GN)
–COPPER LAYER 4 (L4), .5 OZ.

1. TOTAL FINISHED THICKNESS 0.026±.004.
2. PTH PRESENT FROM COPPER LAYER 1 TO COPPER LAYER 4.
3. INDICATED ON TOP VIEW PTH's ARE PLUGGED WITH EPOXY AND CAPPED WITH COPPER FROM TOP SIDE.
4. L2, L3, AND L4 ARE CONTINUOUS GROUND PLANES.

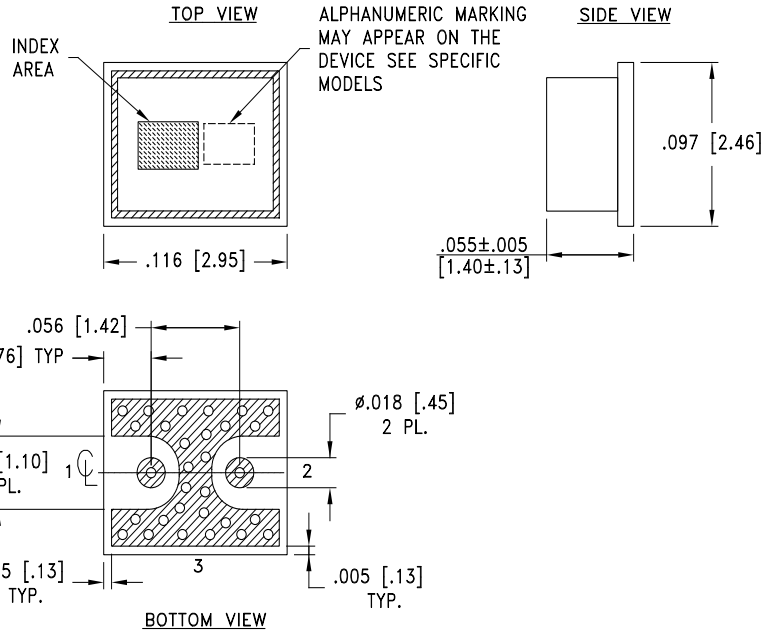
NOTES:
1. PCB IS MULTILAYER PCB, SEE STACK–UP DIAGRAM.
2. TRACE WIDTH & GAP ARE SHOWN FOR MEGTRON–7 R5785(N/GN) WITH DIELECTRIC THICKNESS .0079", COPPER: .5 OZ. EACH LAYER. FOR OTHER MATERIALS TRACE WIDTH & GAP MAY NEED TO BE MODIFIED.
3. LAYERS L2, L3 & L4 OF PCB ARE CONTINUOUS GROUND PLANES.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

Figure 2. HFHKI-6600+ Suggested PCB Layout

CASE STYLE DRAWING



METALLIZATION

Weight: .021 grams
Dimensions are in inches [mm]. Tolerances: 2 Pl.±.01; 3 Pl. ±.005 Inches

PRODUCT MARKING*: W4

*Marking may contain other features or characters for internal lot control.

High Pass Filter

HFHKI-6600+

50Ω 7.2 to 17 GHz

ADDITIONAL DETAILED INFORMATION IS AVAILABLE ON OUR DASHBOARD. CLICK HERE

Performance Data & Graphs	Data Graphs S-Parameter (S2P Files) Data Set (.zip file) De-embedded to device pads
Case Style	NM3723-1 Lead Finish: Gold Plate over Nickel Plate
RoHS Status	Compliant
Tape and Reel	F66-3
Suggested Layout for PCB Design	PL-837
Evaluation Board	TB-HFHKI-6600C+ Gerber File
Environmental Rating	ENV06T10

NOTES

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.

B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.

C. The parts covered by this specification document are subject to Mini-Circuits' standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

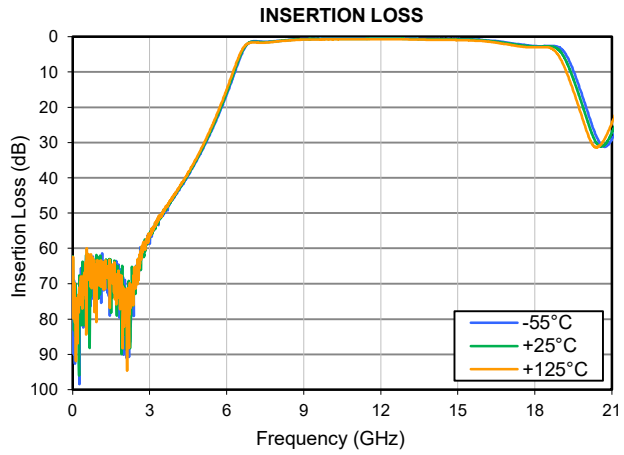
LTCC High pass Filter HFHKI-6600+

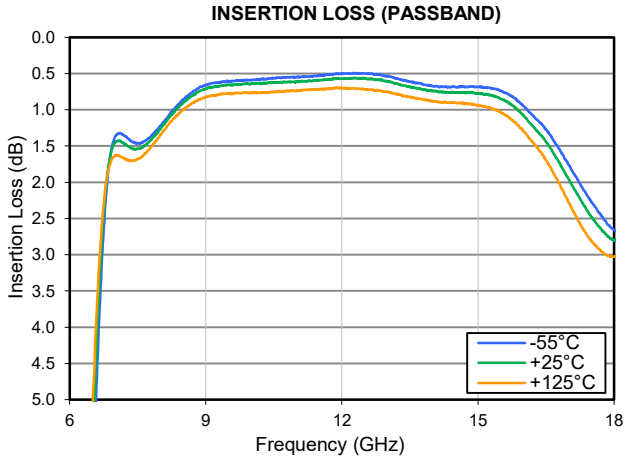
Typical Performance Data

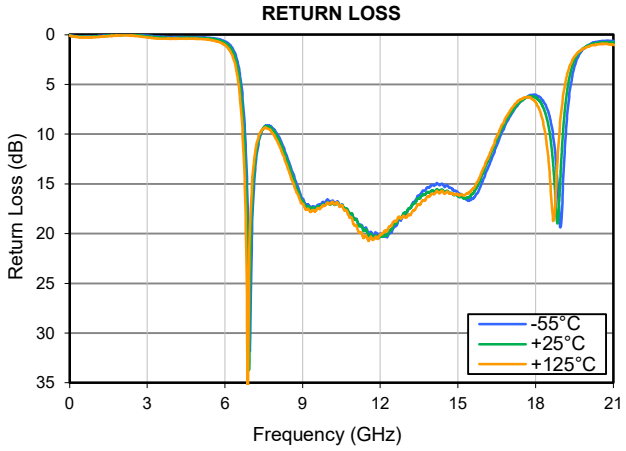
FREQUENCY (GHz)	INSERTION LOSS (dB)			INPUT RETURN LOSS (dB)		
	@-55°C	@+25°C	@+125°C	@-55°C	@+25°C	@+125°C
0.01	66.33	62.23	71.45	0.05	0.04	0.06
0.05	84.40	79.74	77.89	0.09	0.10	0.14
0.50	69.84	70.28	69.90	0.18	0.22	0.26
1.00	69.25	74.25	65.62	0.16	0.21	0.26
1.50	69.11	78.25	68.97	0.07	0.10	0.15
2.00	70.83	73.87	82.25	-0.02	0.04	0.09
2.50	65.76	66.26	66.77	0.00	0.06	0.13
3.00	57.06	55.58	55.78	0.10	0.17	0.27
3.50	50.79	49.95	49.98	0.20	0.28	0.38
4.00	44.81	44.80	44.31	0.25	0.33	0.43
4.50	39.24	38.95	38.45	0.27	0.34	0.43
5.00	32.74	32.43	31.86	0.26	0.33	0.44
5.50	25.27	24.73	24.05	0.33	0.41	0.55
6.00	16.44	15.79	14.95	0.67	0.82	1.05
6.50	6.46	5.86	5.22	2.84	3.46	4.46
7.00	1.37	1.45	1.63	25.99	21.23	17.37
7.40	1.45	1.53	1.70	9.88	9.77	9.68
7.80	1.36	1.42	1.51	9.29	9.46	9.75
8.20	1.06	1.11	1.19	10.92	11.27	11.79
8.60	0.80	0.85	0.95	13.75	14.13	14.69
9.00	0.66	0.71	0.83	16.48	16.74	17.00
9.40	0.61	0.66	0.78	17.26	17.38	17.61
9.80	0.59	0.65	0.76	16.82	17.09	17.21
10.20	0.58	0.63	0.76	16.84	17.00	16.97
10.60	0.56	0.62	0.75	17.48	17.46	17.58
11.00	0.55	0.61	0.74	18.53	18.56	19.16
11.40	0.53	0.60	0.72	19.44	19.65	20.24
11.80	0.51	0.57	0.70	19.98	20.27	20.39
12.20	0.50	0.56	0.71	20.31	20.22	19.79
12.60	0.51	0.57	0.72	19.24	19.00	18.75
13.00	0.54	0.60	0.75	18.04	17.88	18.38
13.40	0.60	0.67	0.81	16.46	16.67	17.28
13.80	0.66	0.72	0.86	15.42	15.88	16.32
14.20	0.69	0.75	0.89	14.92	15.53	15.74
14.60	0.69	0.76	0.91	15.18	15.73	15.82
15.00	0.69	0.78	0.94	15.90	16.20	16.08
15.40	0.71	0.82	1.00	16.66	16.40	15.94
15.80	0.84	0.96	1.17	15.70	15.01	14.58
16.20	1.07	1.22	1.44	13.18	12.50	12.21
16.60	1.35	1.53	1.80	10.48	10.00	9.68
17.00	1.76	1.96	2.28	8.26	8.05	7.72

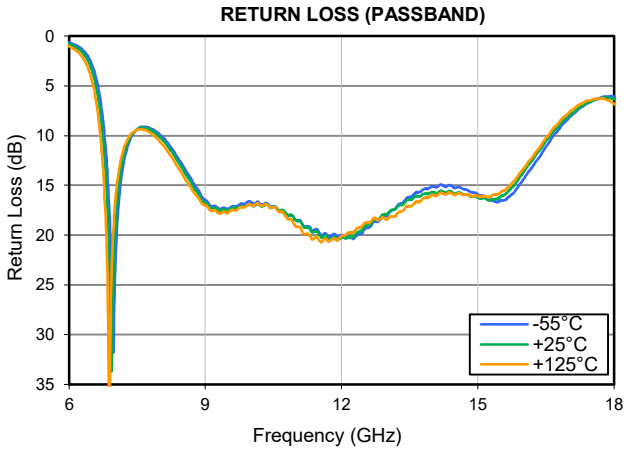
LTCC High pass Filter HFHKI-6600+

Typical Performance Data





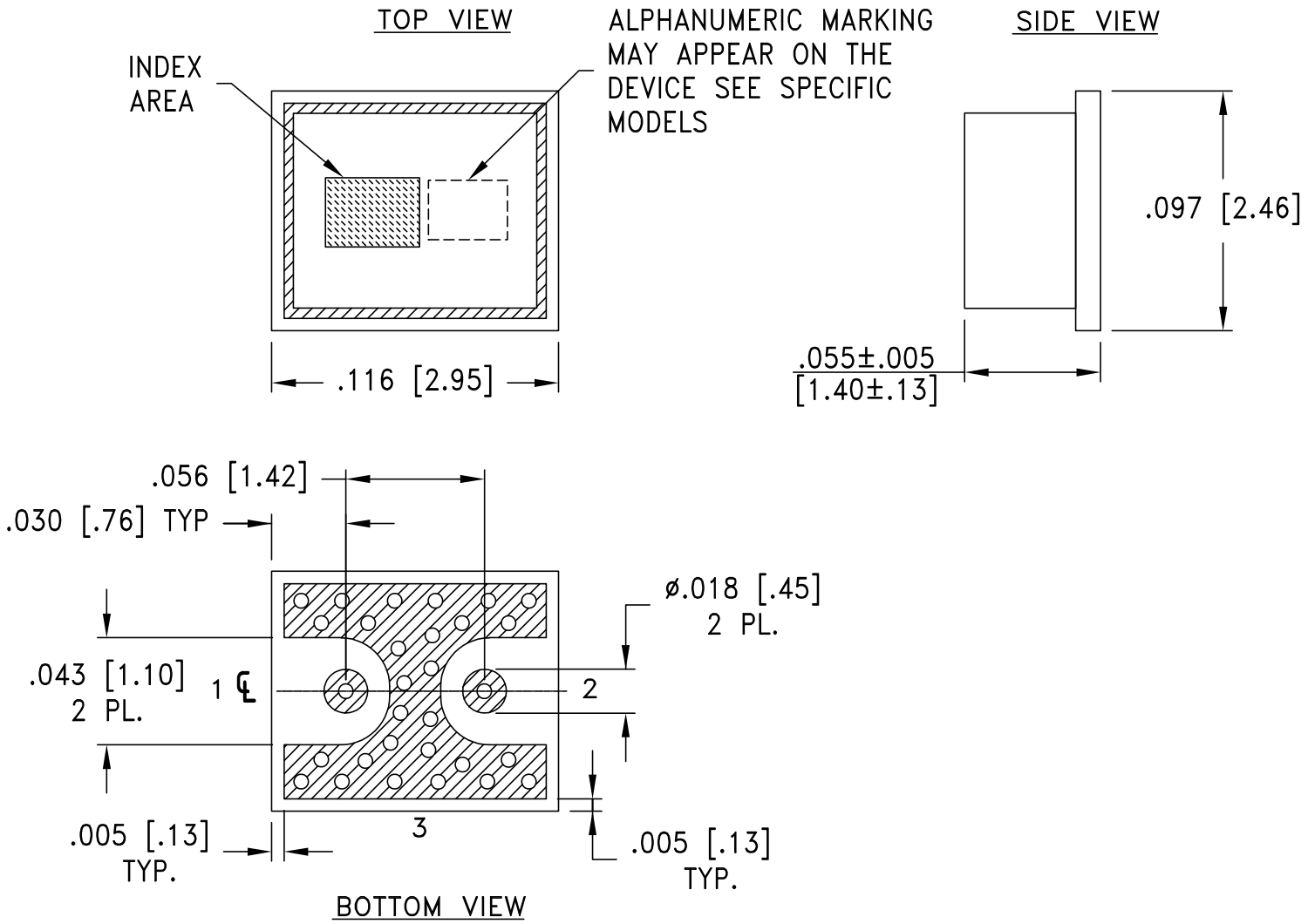




Case Style NM

Outline Dimensions

NM3723-1



Weight: .021 grams

Dimensions are in inches [mm]. Tolerances: 2 Pl.±.01; 3 Pl. ±.005 inches

Notes:

1. Case material: LTCC on printed circut board base.
2. Termination Finish: **as shown below or indicated on Data Sheet.**
   For RoHS Case Styles: Gold Plate over Nickel plate. All models, (+) suffix.

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INTERNET http://www.minicircuits.com

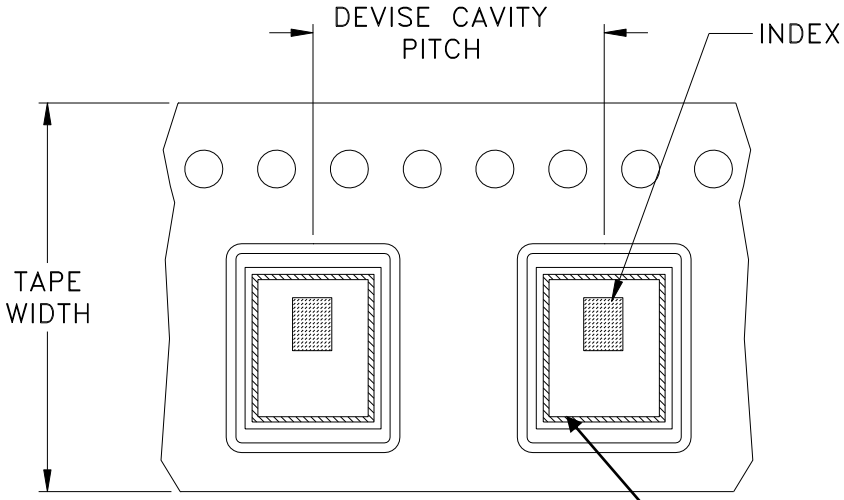
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Tape & Reel Packaging TR-F66-3



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note	
8	4	7	Small quantity standard	20
				50
				100
				200
				500
		7	Standard	1000

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

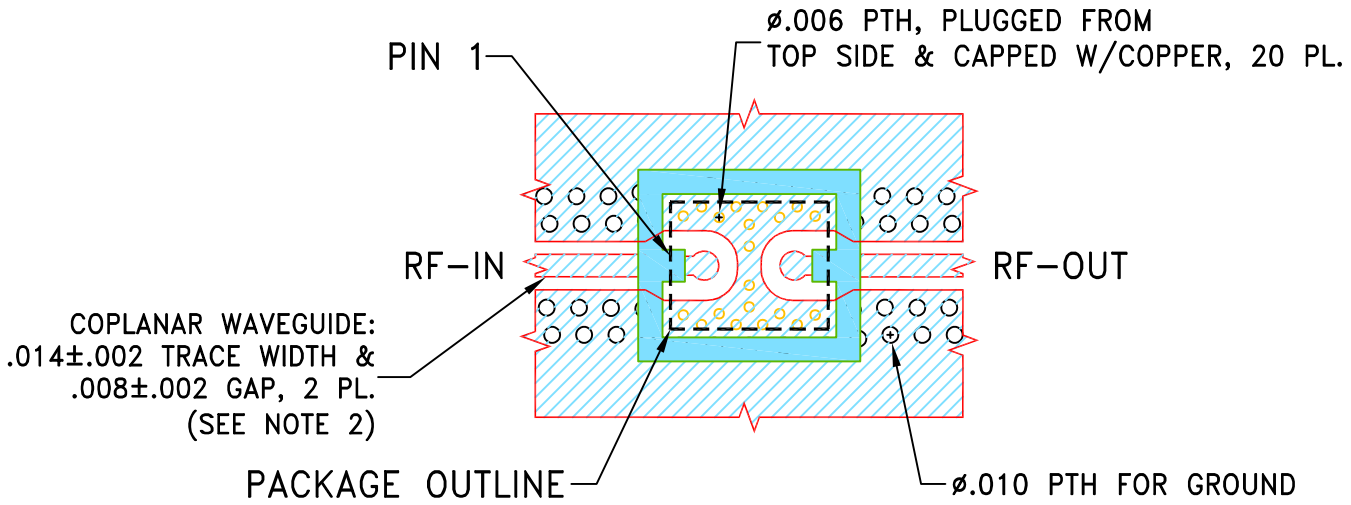
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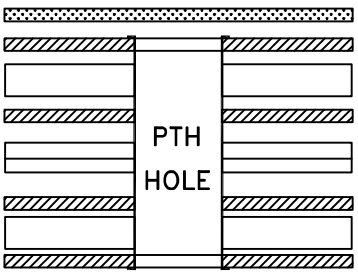
THIRD ANGLE PROJECTION

REVISIONS					
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	ECO-026948	NEW RELEASE	09/15/25	ITG	IL

SUGGESTED MOUNTING CONFIGURATION FOR NM3723-1 CASE STYLE



STACK-UP DIAGRAM



-SOLDER MASK (TOP-SLD)
-COPPER LAYER 1(L1), .5 OZ.
-CORE 1, .0079 MEGTRON-7 R5785(N/GN)
-COPPER LAYER 2 (L2), .5 OZ.
-PREPREG, .0035 (89 um) MEGTRON-7 R5680(N/GN), CLOTH STYLE:1078
-PREPREG, .0035 (89 um) MEGTRON-7 R5680(N/GN), CLOTH STYLE:1078
-COPPER LAYER 3 (L3), .5 OZ.
-CORE 2, .0079 MEGTRON-7 R5785(N/GN)
-COPPER LAYER 4 (L4), .5 OZ.

1. TOTAL FINISHED THICKNESS 0.026±.004.
2. PTH PRESENT FROM COPPER LAYER 1 TO COPPER LAYER 4.
3. INDICATED ON TOP VIEW PTH's ARE PLUGGED WITH EPOXY AND CAPPED WITH COPPER FROM TOP SIDE.
4. L2, L3, AND L4 ARE CONTINUOUS GROUND PLANES.

NOTES:

1. PCB IS MULTILAYER PCB, SEE STACK-UP DIAGRAM.
2. TRACE WIDTH & GAP ARE SHOWN FOR MEGTRON-7 R5785(N/GN) WITH DIELECTRIC THICKNESS .0079", COPPER: 1 OZ. EACH LAYER. FOR OTHER MATERIALS TRACE WIDTH & GAP MAY NEED TO BE MODIFIED.
3. LAYERS L2, L3 & L4 OF PCB ARE CONTINUOUS GROUND PLANES.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN	ITG	09/15/25
TOLERANCES ON:	CHECKED	GF	09/15/25
2 PL DECIMALS ±	APPROVED	IL	09/15/25
3 PL DECIMALS ± .005			
ANGLES ±			
FRACTIONS ±			

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ASHEETA1.DWG REV:A DATE:01/12/95

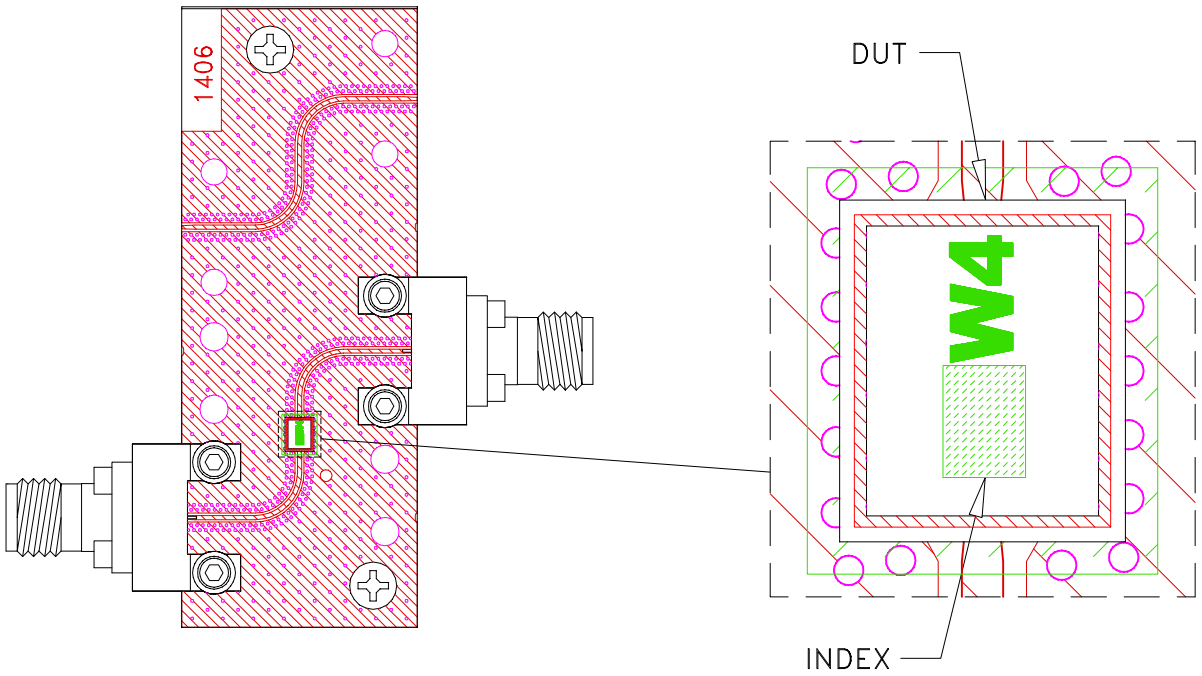
Mini-Circuits® 13 Neptune Avenue Brooklyn NY 11235

PL, NM3723-1, TB-HFHKI-2200C+

SIZE	CODE IDENT	DRAWING NO:	REV:
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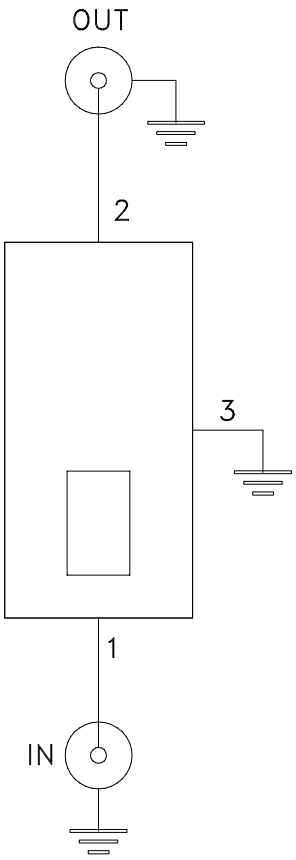
FILE:	SCALE:	SHEET:
98PL837	8:1	1 OF 1

Evaluation Board and Circuit



(SCALE 15:1)

TB-HFHKI-6600C+



Schematic Diagram

1. 50 Ohm 2.4 mm Female end Launch connectors.
2. PCB Material: MEGTRON-7 R5785 (N or GN) or equivalent, Dielectric Constant= 3.37 Thickness=.0079 inch.

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Mini-Circuits

Environmental Specifications ENV06T10

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Solder Reflow Heat	Sn-Pb Eutectic Process 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020C, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Test B,B1, 95% Coverage
Thermal Shock	-55° to +125°C, 15 min dwell,250 cycles	MIL-STD-202, Method 107
Bend Test	1mm, deflection for 5 seconds Span of bending: 2.75"	--
High Temp Storage	125°C to 1000 Hrs	---

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